**IRFF120** 



# REPETITIVE AVALANCHE AND dv/dt RATED HEXFET<sup>®</sup> TRANSISTORS THRU-HOLE TO-205AF (TO-39)

## Product Summary

Part Number	BVDSS	RDS(on)	Ι <sub>D</sub>
IRFF120	100V	0.30Ω	6.0A

# 100V, N-CHANNEL REF: MIL-PRF-19500/555

**JANTX2N6788** 

**JANTXV2N6788** 



## Description

The HEXFET<sup>®</sup> technology is the key to International Rectifier's HiRel advanced line of power MOSFET transistors. The efficient geometry and unique processing of this latest "State of the Art" design achieves: very low on state resistance combined with high trans conductance.

The HEXFET transistors also feature all of the well established advantages of MOSFETs such as voltage control, very fast switching and temperature stability of the electrical parameters.

They are well suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers and high energy pulse circuits.

#### Features

- Repetitive Avalanche Ratings
- Dynamic dv/dt Rating
- Hermetically Sealed
- Simple Drive Requirements
- ESD Rating: Class 1B per MIL-STD-750, Method 1020

Symbol	Parameter	Value	Units	
I <sub>D1</sub> @ V <sub>GS</sub> = 10V, T <sub>C</sub> = 25°C	Continuous Drain Current	6.0		
$I_{D2} @ V_{GS} = 10V, T_C = 100^{\circ}C$	Continuous Drain Current	3.5	А	
I <sub>DM</sub> @ T <sub>C</sub> = 25°C	Pulsed Drain Current ①	24		
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Maximum Power Dissipation	20	W	
	Linear Derating Factor	0.16	W/°C	
V <sub>GS</sub>	Gate-to-Source Voltage	± 20	V	
E <sub>AS</sub>	Single Pulse Avalanche Energy 2	0.242	mJ	
I <sub>AR</sub>	Avalanche Current ①	2.2	А	
E <sub>AR</sub>	Repetitive Avalanche Energy ①	2.0	mJ	
dv/dt	Peak Diode Recovery dv/dt 3	5.5	V/ns	
TJ	Operating Junction and	-55 to + 150		
T <sub>STG</sub>	Storage Temperature Range	-55 10 + 150	°C	
	Lead Temperature	300 (0.063 in. /1.6 mm from case for 10s)		
	Weight	0.98 (Typical)	g	

#### **Absolute Maximum Ratings**

For Footnotes, refer to the page 2.



Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified) Symbol Parameter Min. Typ. Max. Units Test Conditions								
Symbol		Min.	тур.	wax.				
BV <sub>DSS</sub>	Drain-to-Source Breakdown Voltage	100			V	$V_{GS} = 0V, I_{D} = 1.0mA$		
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.10		V/°C	Reference to $25^{\circ}$ C, I <sub>D</sub> = 1.0mA		
D	Static Drain-to-Source On-Resistance			0.30	Ω	V <sub>GS</sub> = 10V, I <sub>D2</sub> = 3.5A ④		
R <sub>DS(on)</sub>				0.35		V <sub>GS</sub> = 10V, I <sub>D1</sub> = 6.0A ④		
V <sub>GS(th)</sub>	Gate Threshold Voltage	2.0		4.0	V	$V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A		
Gfs	Forward Transconductance	1.5			S	V <sub>DS</sub> = 15V, I <sub>D2</sub> = 3.5A ④		
I <sub>DSS</sub>	Zero Gate Voltage Drain Current			25		$V_{DS}$ = 80 V, $V_{GS}$ = 0V		
				250	μA	$V_{DS} = 80V, V_{GS} = 0V, T_{J} = 125^{\circ}C$		
I <sub>GSS</sub>	Gate-to-Source Leakage Forward			100	nA	V <sub>GS</sub> = 20V		
	Gate-to-Source Leakage Reverse			-100		V <sub>GS</sub> = -20V		
$Q_{G}$	Total Gate Charge	7.7		18		I <sub>D1</sub> = 6.0A		
$Q_{GS}$	Gate-to-Source Charge	0.7		4.0	nC	V <sub>DS</sub> = 50V		
$Q_{GD}$	Gate-to-Drain ('Miller') Charge	2.0		9.0		V <sub>GS</sub> = 10V		
t <sub>d(on)</sub>	Turn-On Delay Time			40		V <sub>DD</sub> = 35V		
tr	Rise Time			70	20	I <sub>D1</sub> = 6.0A		
t <sub>d(off)</sub>	Turn-Off Delay Time			40	ns	R <sub>G</sub> = 7.5Ω		
t <sub>f</sub>	Fall Time			70		V <sub>GS</sub> = 10V		
Ls +L <sub>D</sub>	Total Inductance		7.0		nH	Measured from Drain lead (6mm / 0.25 in from package) to Source lead (6mm/ 0.25 in from package) with Source wire internally bonded from Source pin to Drain pin		
C <sub>iss</sub>	Input Capacitance		350			V <sub>GS</sub> = 0V		
C <sub>oss</sub>	Output Capacitance		150		pF	V <sub>DS</sub> = 25V		
C <sub>rss</sub>	Reverse Transfer Capacitance		24			f = 1.0MHz		

### Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

### Source-Drain Diode Ratings and Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
I <sub>S</sub>	Continuous Source Current (Body Diode)			6.0	Δ	
I <sub>SM</sub>	Pulsed Source Current (Body Diode) ①			24	A	
V <sub>SD</sub>	Diode Forward Voltage			1.8	V	$T_J = 25^{\circ}C, I_S = 6.0A, V_{GS} = 0V$
t <sub>rr</sub>	Reverse Recovery Time			240	ns	$T_J = 25^{\circ}C, I_F = 6.0A, V_{DD} \le 50V$
Q <sub>rr</sub>	Reverse Recovery Charge			2.0	μC	di/dt = 100A/µs ④
t <sub>on</sub>	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by $L_{\text{S}}\text{+}L_{\text{D}})$				

#### **Thermal Resistance**

Symbol	Parameter	Min.	Тур.	Max.	Units	
$R_{ ext{ heta}JC}$	Junction-to-Case			6.25	°C/W	
R <sub>0JA</sub>	Junction-to-Ambient (Typical Socket Mount)			175		

#### Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- $@~V_{\text{DD}}$  = 25V, starting  $T_{\text{J}}$  = 25°C, Peak I\_L = 2.2A, L = 100  $\mu H$
- 3  $~I_{SD}$   $\leq$  6.0A, di/dt  $\leq$  110A/µs,  $V_{DD}$   $\leq$  100V,  $T_{J}$   $\leq$  150°C, Suggested  $R_{G}$  = 7.5  $\Omega$
- (4) Pulse width  $\leq$  300 µs; Duty Cycle  $\leq$  2%



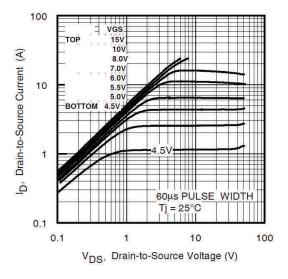


Fig 1. Typical Output Characteristics

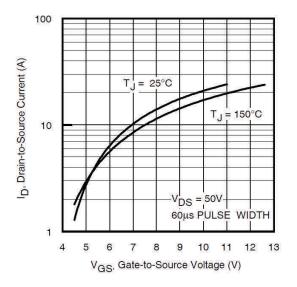
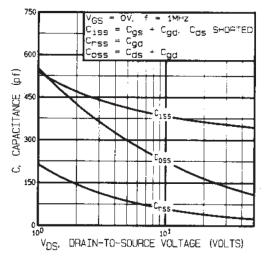
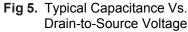


Fig 3. Typical Transfer Characteristics





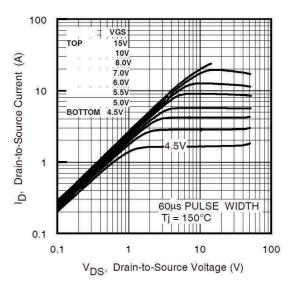


Fig 2. Typical Output Characteristics

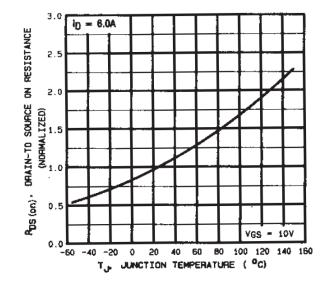
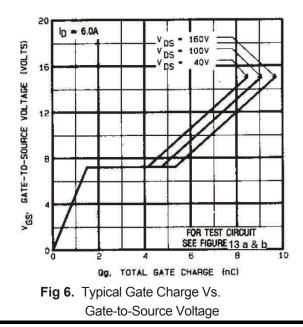
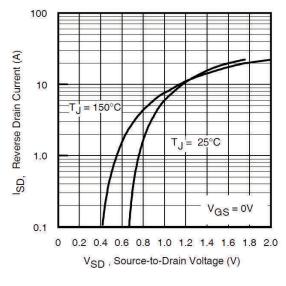
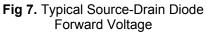


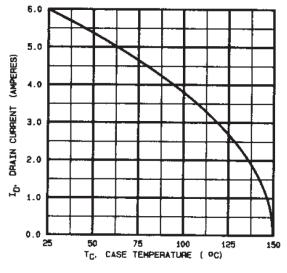
Fig 4. Normalized On-Resistance Vs. Temperature













## IRFF120 JANTX2N6788/JANTXV2N6788

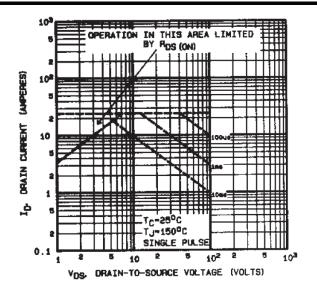
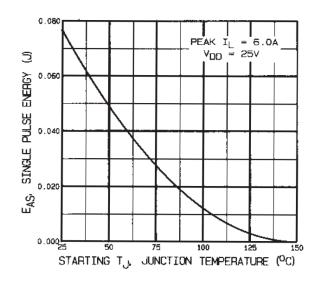
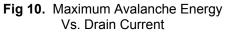


Fig 8. Maximum Safe Operating Area





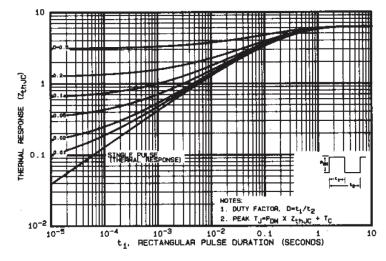


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

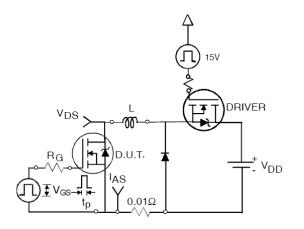
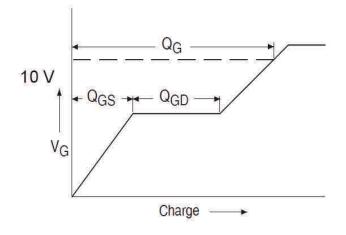


Fig 12a. Unclamped Inductive Test Circuit





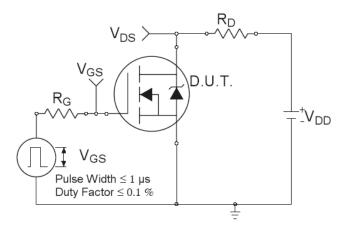
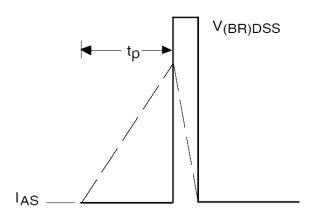
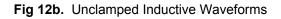


Fig 14a. Switching Time Test Circuit





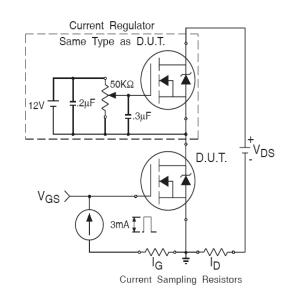
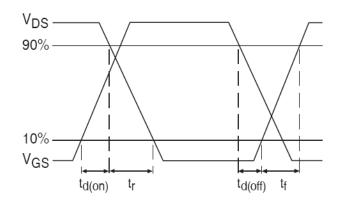
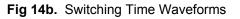


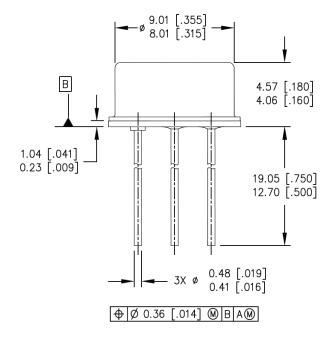
Fig 13b. Gate Charge Test Circuit

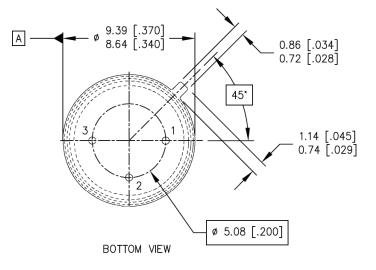






## Case Outline and Dimensions - TO-205AF (TO-39)





LEGEND 1- SOURCE 2- GATE 3- DRAIN (CONNECTED TO THE CASE)



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SIDE VIEW

- 1. DIMENSIONING AND TOLERANCING PER ASME 14.5M-1994.
- 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 3. CONTROLLING DIMENSION: INCH.
- 4. CONFORMS TO JEDEC OUTLINE TO-205AF (TO-39).



#### **IMPORTANT NOTICE**

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